Qualcomm Innovation Fellowship

Research and Development is the key to creating new technologies. Qualcomm Research is excited to announce the Qualcomm Innovation Fellowship which promotes Qualcomm’s core values of innovation, execution, and partnering.

For more information, visit www.qualcomm.com/qinf
Email any questions to: innovation.fellowship@qualcomm.com

Application Areas for Proposals

- RF Related
- Internet of Everything (IoE)
- Mobile Security & Privacy
- Processor Architecture & Implementation
- Software System Architecture
- Computational Photography; Mobile Graphics & Imaging, Mobile Gaming
- User Interfaces
- Semiconductor Research
- Advances in Communication Techniques and Theory
- Neuromorphic Computing
- Mobile Applications and App Enablers
- Robotics and UAV
- Hardware System Architecture

Participating Schools

California Institute of Technology
Carnegie Mellon University
Columbia University in the City of New York
Cornell University
Georgia Institute of Technology
Massachusetts Institute of Technology
Princeton University
Rutgers University
Stanford University
UC Berkeley
UC Los Angeles
UC San Diego
University of Illinois, Urbana-Champaign
University of Maryland, College Park
University of Michigan
University of Southern California
University of Texas at Austin
University of Washington

Awards

- Eight winning teams with 2 students per team
- $100,000 Fellowship per team
- Collaborate with Qualcomm Researchers on your Proposal
- Travel to Qualcomm Facilities

Proposal Submission Deadline
November 3, 2014

Finalists Announcement
December 15, 2014

Finalists Presentations
March 23-27, 2015

Winners Announcement
April 13, 2015

QInF Day
September 2015

Application Process

Each team must submit the following items (in PDF or Word format) online:

- Three page proposal summarizing the innovative idea
- Letter from one or more faculty recommending the innovation
- CV of student team members